Integrated Device Technology, Inc.

3.3V CMOS 9-BIT, 4-PORT UNIVERSAL BUS EXCHANGER WITH 3-STATE OUTPUTS AND BUS-HOLD

IDT74ALVCHR162409
ADVANCE INFORMATION

FEATURES:

- 0.5 MICRON CMOS Technology
- Typical $t_{SK(0)}$ (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- 0.635mm pitch SSOP, 0.50mm pitch TSSOP, and 0.40mm pitch TVSOP packages
- Extended commercial range of – 40°C to +85°C
- V_{CC} = 3.3V ±0.3V, Normal Range
- V_{CC} = 2.7V to 3.6V, Extended Range
- V_{CC} = 2.5V ±0.2V
- CMOS power levels (0.4µW typ. static)
- Rail-to-Rail output swing for increased noise margin

Drive Features for ALVCHR162409:

- Balanced Output Drivers: ±12mA
- Low switching noise

APPLICATIONS:

- 3.3V High Speed Systems
- 3.3V and lower voltage computing systems

DESCRIPTION:

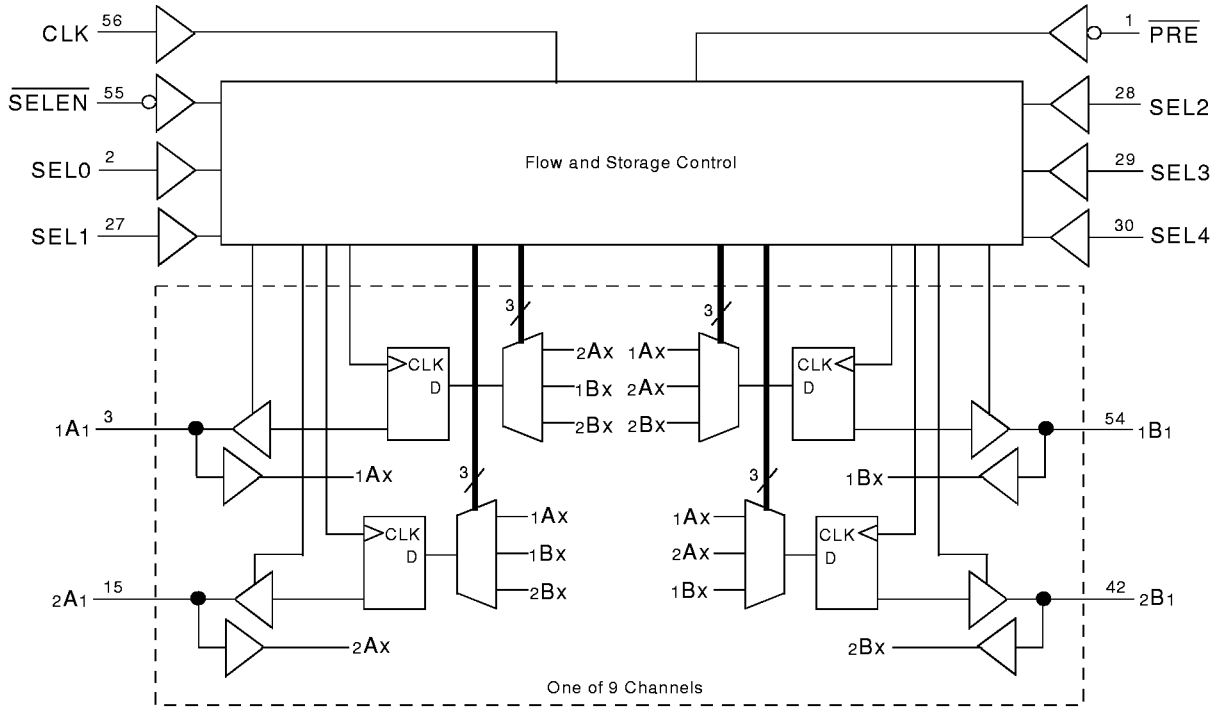
This 9-bit, 4-port universal bus exchanger is built using advanced dual metal CMOS technology. The ALVCHR162409 allows synchronous data exchange between four different buses. Data flow is controlled by the select (SEL0–SEL4) inputs. A data-flow state is stored on the rising edge of the clock (CLK) input if the select-enable ($\overline{SELEN}$) input is low. Once a data-flow state has been established, data is stored in the flip-flop on the rising edge of CLK if $\overline{SELEN}$ is high. The data-flow control logic is designed to allow glitch-free data transmission.

When preset ($\overline{PRE}$) transitions high, the outputs are disabled immediately without waiting for a clock pulse. To leave the high-impedance state, both $\overline{PRE}$ and $\overline{SELEN}$ must be low and a clock pulse must be applied.

The ALVCHR162409 has series resistors in the device output structure which will significantly reduce line noise when used with light loads. This driver has been designed to drive ±12mA at the designated threshold levels.

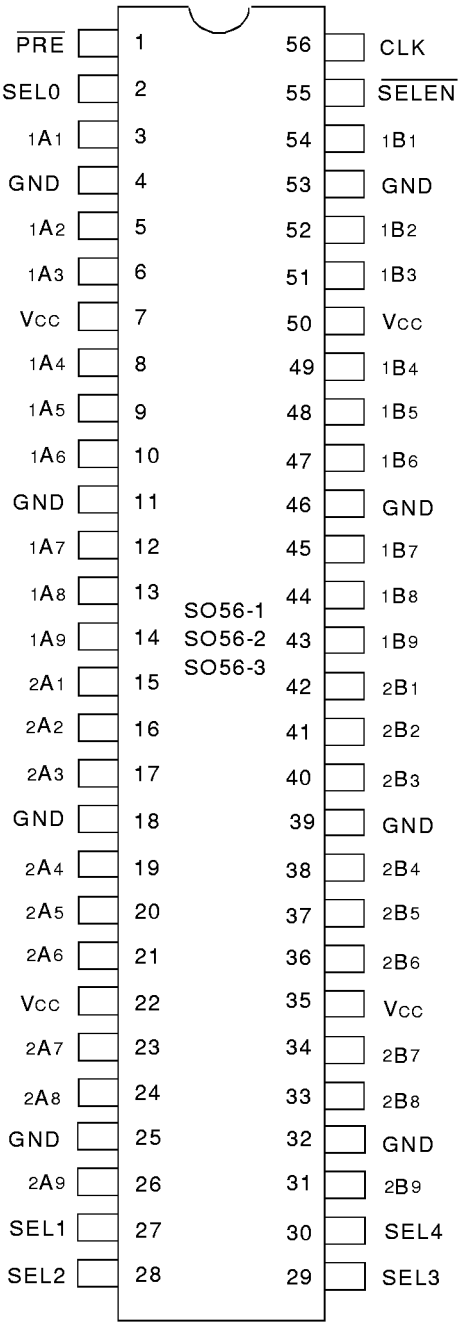
The ALVCHR162409 has "bus-hold" which retains the inputs' last state whenever the input bus goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.

FUNCTIONAL BLOCK DIAGRAM



The IDT logo is a registered trademark of Integrated Device Technology, Inc.

PIN CONFIGURATION



SSOP/
TSSOP/TVSOP
TOP VIEW

CAPACITANCE (T_A = +25°C, f = 1.0MHz)

Symbol	Parameter[1]	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	5	7	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	7	9	pF
$C_{I/O}$	I/O Port Capacitance	V_{IN} = 0V	7	9	pF

ALVC Link

NOTE:
1. As applicable to the device type.

ABSOLUTE MAXIMUM RATING[1]

Symbol	Description	Max.	Unit
V_{TERM}[2]	Terminal Voltage with Respect to GND	– 0.5 to + 4.6	V
V_{TERM}[3]	Terminal Voltage with Respect to GND	– 0.5 to V_{CC} + 0.5	V
T_{STG}	Storage Temperature	– 65 to + 150	°C
I_{OUT}	DC Output Current	– 50 to + 50	mA
I_{IK}	Continuous Clamp Current, V_I < 0 or V_I > V_{CC}	± 50	mA
I_{OK}	Continuous Clamp Current, V_O < 0	– 50	mA
I_{CC} I_{SS}	Continuous Current through each V_{CC} or GND	±100	mA

ALVC Link

NOTES:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V_{CC} terminals.
3. All terminals except V_{CC}.

PIN DESCRIPTION

Pin Names	Description
$\overline{PRE}$	Preset Input (Active LOW)
$\overline{SELEN}$	Select Enable Input (Active LOW)
SEL0-SEL4	Select Inputs
CLK	Clock Input
xAx	A-to-B Data Inputs or B-to-A 3-State Outputs[1]
xBx	B-to-A Data Inputs or A-to-B 3-State Outputs[1]

NOTE:
1. These pins have "Bus-Hold." All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE[1]

Inputs		Output
CLK	**Send Port**	**Receive Port**
↑	L	L
↑	H	H
H	X	B_O[2]
L	X	B_O[2]

NOTES:
1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't Care
   ↑ = LOW-to-HIGH Transition
2. B_O = Output level before the indicated steady-state input conditions were established

DATA FLOW CONTROL

Inputs								Data Flow
$\overline{PRE}$	$\overline{SELEN}$	CLK	SEL0	SEL1	SEL2	SEL3	SEL4	
H	X	X	X	X	X	X	X	All outputs disabled
L	H	↑	X	X	X	X	X	No change
L	L	↑	0	0	0	0	0	None, all I/Os off
L	L	↑	0	0	0	0	1	Not used
L	L	↑	0	0	0	1	0	Not used
L	L	↑	0	0	0	1	1	Not used
L	L	↑	0	0	1	0	0	Not used
L	L	↑	0	0	1	0	1	Not used
L	L	↑	0	0	1	1	0	Not used
L	L	↑	0	0	1	1	1	Not used
L	L	↑	0	1	0	0	0	2A to 1A and 1B to 2B
L	L	↑	0	1	0	0	1	2A to 1A
L	L	↑	0	1	0	1	0	2B to 1B
L	L	↑	0	1	0	1	1	2A to 1A and 2B to 1B
L	L	↑	0	1	1	0	0	1A to 2A and 1B to 2B
L	L	↑	0	1	1	0	1	1A to 2A
L	L	↑	0	1	1	1	0	1B to 2B
L	L	↑	0	1	1	1	1	1A to 2A and 2B to 1B
L	L	↑	1	0	0	0	0	1A to 1B and 2B to 2A
L	L	↑	1	0	0	0	1	1A to 1B
L	L	↑	1	0	0	1	0	2A to 2B
L	L	↑	1	0	0	1	1	1A to 1B and 2A to 2B
L	L	↑	1	0	1	0	0	1B to 1A and 2A to 2B
L	L	↑	1	0	1	0	1	1B to 1A
L	L	↑	1	0	1	1	0	2B to 2A
L	L	↑	1	0	1	1	1	1B to 1A and 2B to 2A
L	L	↑	1	1	0	0	0	2B to 1A and 2A to 1B
L	L	↑	1	1	0	0	1	1B to 2A
L	L	↑	1	1	0	1	0	2B to 1A
L	L	↑	1	1	0	1	1	2B to 1A and 1B to 2A
L	L	↑	1	1	1	0	0	1A to 2B and 1B to 2A
L	L	↑	1	1	1	0	1	1A to 2B
L	L	↑	1	1	1	1	0	2A to 1B
L	L	↑	1	1	1	1	1	1A to 2B and 2A to 1B

BUS-HOLD CHARACTERISTICS

Symbol	Parameter[1]	Test Conditions		Min.	Typ.[2]	Max.	Unit
I_{BHH}	Bus-Hold Input Sustain Current	V_{CC} = 3.0V	V_I = 2.0V	– 75	—	—	µA
I_{BHL}			V_I = 0.8V	75	—	—	
I_{BHH}	Bus-Hold Input Sustain Current	V_{CC} = 2.3V	V_I = 1.7V	– 45	—	—	µA
I_{BHL}			V_I = 0.7V	45	—	—	
I_{BHHO}	Bus-Hold Input Overdrive Current	V_{CC} = 3.6V	V_I = 0 to 3.6V	—	—	± 500	µA
I_{BHLO}							

NOTES:
1. Pins with Bus-hold are identified in the pin description.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient.

ALVC Link

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Operating Condition: T_A = – 40°C to +85°C

Symbol	Parameter	Test Conditions		Min.	Typ.(1)	Max.	Unit
V_{IH}	Input HIGH Voltage Level	V_{CC} = 2.3V to 2.7V		1.7	—	—	V
		V_{CC} = 2.7V to 3.6V		2	—	—	
V_{IL}	Input LOW Voltage Level	V_{CC} = 2.3V to 2.7V		—	—	0.7	V
		V_{CC} = 2.7V to 3.6V		—	—	0.8	
I_{IH}	Input HIGH Current	V_{CC} = 3.6V	V_I = V_{CC}	—	—	± 5	µA
I_{IL}	Input LOW Current	V_{CC} = 3.6V	V_I = GND	—	—	± 5	
I_{OZH}	High Impedance Output Current	V_{CC} = 3.6V	V_O = V_{CC}	—	—	± 10	µA
I_{OZL}	(3-State Output pins)		V_O = GND	—	—	± 10	µA
V_{IK}	Clamp Diode Voltage	V_{CC} = 2.3V, I_{IN} = – 18mA		—	– 0.7	– 1.2	V
V_H	Input Hysteresis	V_{CC} = 3.3V		—	100	—	mV
I_{CCL} I_{CCH} I_{CCZ}	Quiescent Power Supply Current	V_{CC} = 3.6V V_{IN} = GND or V_{CC}		—	0.1	40	µA
ΔI_{CC}	Quiescent Power Supply Current Variation	One input at V_{CC} – 0.6V, other inputs at V_{CC} or GND		—	—	750	µA

ALVC Link

NOTE:
1. Typical values are at V_{CC} = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions(1)		Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = 2.3V to 3.6V	I_{OH} = – 0.1mA	V_{CC} – 0.2	—	V
		V_{CC} = 2.3V	I_{OH} = – 4mA	1.9	—	
			I_{OH} = – 6mA	1.7	—	
		V_{CC} = 2.7V	I_{OH} = – 4mA	2.2	—	
			I_{OH} = – 8mA	2	—	
		V_{CC} = 3.0V	I_{OH} = – 6mA	2.4	—	
			I_{OH} = – 12mA	2	—	
V_{OL}	Output LOW Voltage	V_{CC} = 2.3V to 3.6V	I_{OL} = 0.1mA	—	0.2	V
		V_{CC} = 2.3V	I_{OL} = 4mA	—	0.4	
			I_{OL} = 6mA	—	0.55	
		V_{CC} = 2.7V	I_{OL} = 4mA	—	0.4	
			I_{OL} = 8mA	—	0.6	
		V_{CC} = 3.0V	I_{OL} = 6mA	—	0.55	
			I_{OL} = 12mA	—	0.8	

ALVC Link

NOTE:
1. V_{IH} and V_{IL} must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V_{CC} range. T_A = – 40°C to + 85°C.

OPERATING CHARACTERISTICS, T_A= 25°C

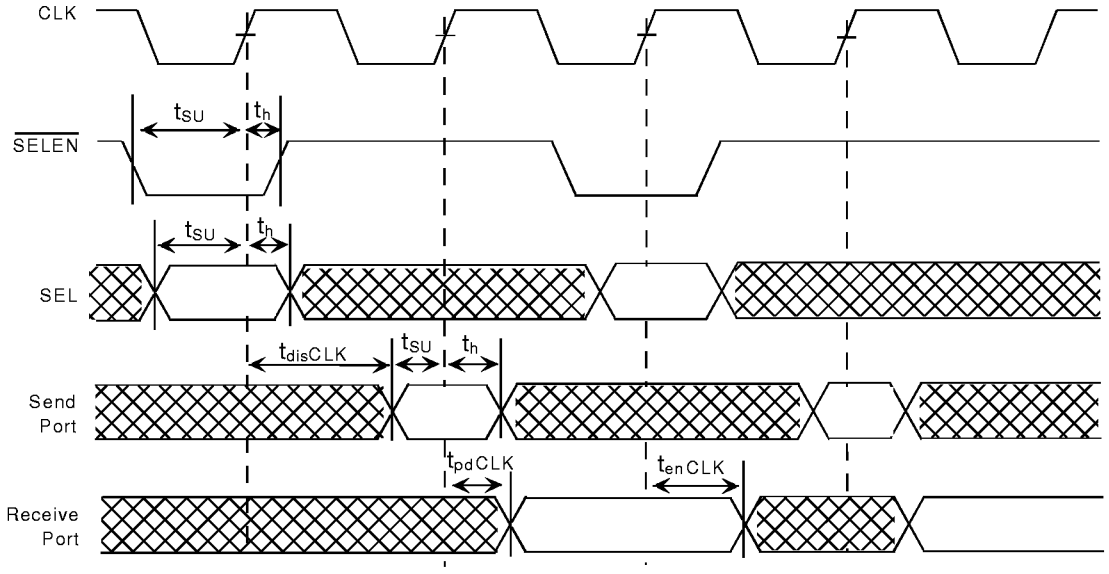
Symbol	Parameter	Test Conditions	V_{CC} = 2.5V ± 0.2V	V_{CC} = 3.3V ± 0.3V	Unit
			Typical	Typical	
C_{PD}	Power Dissipation Capacitance per exchanger Outputs enabled	C_L = 0pF, f = 10Mhz		60	pF
C_{PD}	Power Dissipation Capacitance per exchanger Outputs disabled			60	pF

SWITCHING CHARACTERISTICS[1]

Symbol	Parameter	Vcc = 2.5V ± 0.2V		Vcc = 2.7V		Vcc = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
f_{MAX}		120	—	120	—	120	—	MHz
t_{PLH} t_{PHL}	Propagation Delay CLK to xAx or xBx	1.5	6.9	—	7	1.5	6.2	ns
t_{PZH} t_{PZL}	Output Enable Time CLK to xAx or xBx	2.4	7.8	—	7.6	2	6.8	ns
t_{PHZ} t_{PLZ}	Output Disable Time CLK to xAx or xBx	2.3	7.1	—	6.4	2	6.1	ns
t_{PHZ} t_{PLZ}	Output Disable Time $\overline{PRE}$ to xAx or xBx	2.8	7.7	—	7	2.5	6.4	ns
t_{SU}	Setup Time, xAx or xBx before CLK↑	1.9	—	1.9	—	1.4	—	ns
t_H	Hold Time, xAx or xBx after CLK↑	0.8	—	0.8	—	1	—	ns
t_{SU}	Setup Time, SEL before CLK↑	5.1	—	4.2	—	3.5	—	ns
t_H	Hold Time, SEL after CLK↑	0	—	0	—	0	—	ns
t_{SU}	Setup Time, $\overline{SELEN}$ before CLK↑	2.5	—	2.5	—	1.8	—	ns
t_H	Hold Time, $\overline{SELEN}$ after CLK↑	0.5	—	0.5	—	0.8	—	ns
t_{SU}	Setup Time, $\overline{PRE}$ before CLK↑	1	—	1	—	0.7	—	ns
tw	Pulse Width, CLK HIGH or LOW	4.2	—	4.2	—	3	—	ns
$t_{SK(o)}$	Output Skew[2]	—	—	—	—	—	500	ps

NOTES:
1. See test circuits and waveforms. T_A = – 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

TIMING DIAGRAM



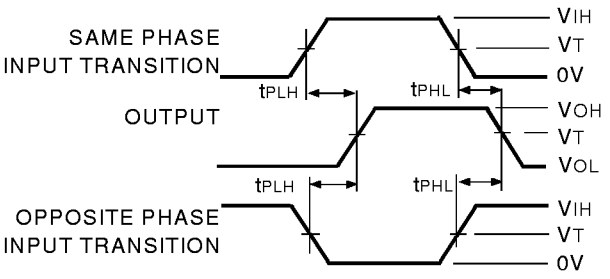
TEST CIRCUITS AND WAVEFORMS:

TEST CONDITIONS

Symbol	Vcc[1] = 3.3V±0.3V	Vcc[1] = 2.7V	Vcc[2] = 2.5V±0.2V	Unit
V_{LOAD}	6	6	2 x Vcc	V
V_{IH}	2.7	2.7	Vcc	V
V_T	1.5	1.5	Vcc / 2	V
V_{LZ}	300	300	150	mV
V_{HZ}	300	300	150	mV
C_L	50	50	30	pF

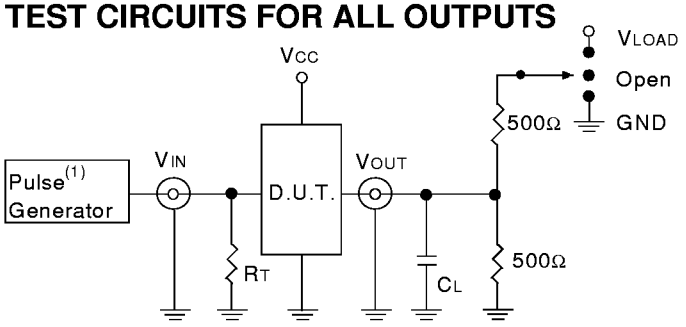
ALVC Link

PROPAGATION DELAY



ALVC Link

TEST CIRCUITS FOR ALL OUTPUTS



ALVC Link

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

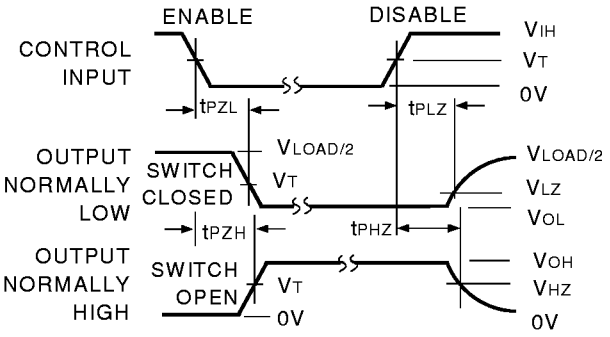
1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_F ≤ 2.5ns; t_R ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_F ≤ 2ns; t_R ≤ 2ns.

SWITCH POSITION:

Test	Switch
Open Drain Disable Low Enable Low	V_{LOAD}
Disable High Enable High	GND
All Other tests	Open

ALVC Link

ENABLE AND DISABLE TIMES

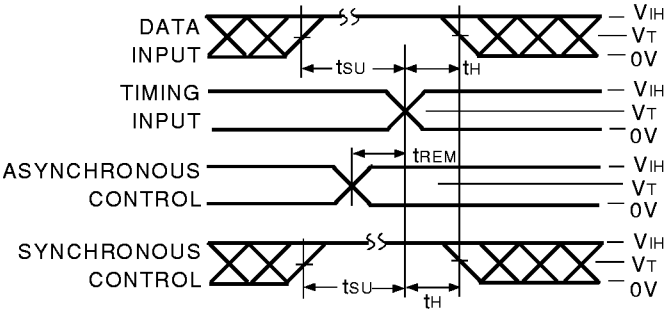


ALVC Link

NOTE:

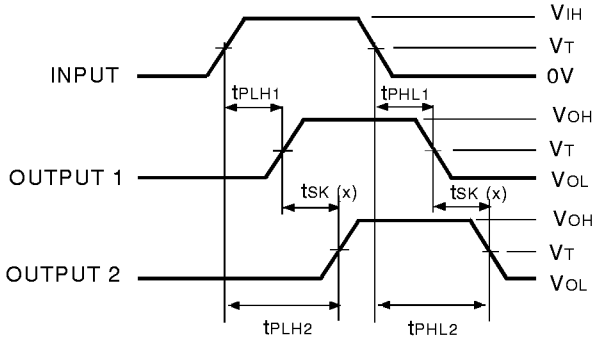
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

SET-UP, HOLD AND RELEASE TIMES



ALVC Link

OUTPUT SKEW - tSK (x)



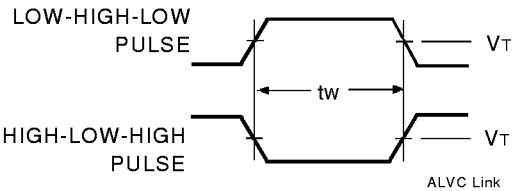
$t_{SK(x)} = |t_{PLH2} - t_{PLH1}|$ or $|t_{PHL2} - t_{PHL1}|$

ALVC Link

NOTES:

1. For t_{SK}(o) OUTPUT1 and OUTPUT2 are any two outputs.
2. For t_{SK}(b) OUTPUT1 and OUTPUT2 are in the same bank.

PULSE WIDTH



ALVC Link

ORDERING INFORMATION